



DISCRETE POWER DIODES and THYRISTORS
DATA BOOK

Bulletin I25171/B



ST333S SERIES

INVERTER GRADE THYRISTORS

Stud Version

Features

- All diffused design
- Center amplifying gate
- Guaranteed high dv/dt
- Guaranteed high di/dt
- High surge current capability
- Low thermal impedance
- High speed performance

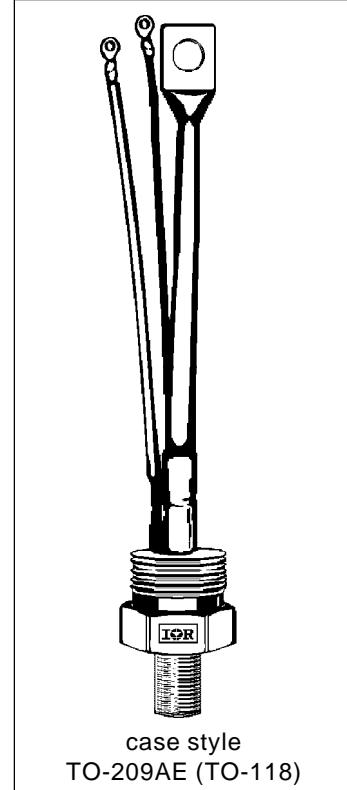
330A

Typical Applications

- Inverters
- Choppers
- Induction heating
- All types of force-commutated converters

Major Ratings and Characteristics

Parameters	ST333S	Units
$I_{T(AV)}$	330	A
@ T_c	75	°C
$I_{T(RMS)}$	518	A
I_{TSM}	11000	A
@ 50Hz	11000	A
@ 60Hz	11520	A
I^2t	605	KA ² s
@ 50Hz	605	KA ² s
@ 60Hz	550	KA ² s
V_{DRM}/V_{RRM}	400 to 800	V
t_q range	10 to 30	μs
T_J	- 40 to 125	°C



ST333S Series**ELECTRICAL SPECIFICATIONS**

Voltage Ratings

Type number	Voltage Code	V_{DRM}/V_{RRM} , maximum repetitive peak voltage V	V_{RSM} , maximum non-repetitive peak voltage V	I_{DRM}/I_{RRM} max. @ $T_J = T_{J\max}$ mA
ST333S	04	400	500	50
	08	800	900	

Current Carrying Capability

Frequency					Units
50Hz	840	600	1280	1040	A
400Hz	650	450	1280	910	
1000Hz	430	230	1090	730	
2500Hz	140	60	490	250	
Recovery voltage V_r	50	50	50	50	V
Voltage before turn-on V_d	V_{DRM}	V_{DRM}	V_{DRM}	V_{DRM}	
Rise of on-state current dI/dt	50	50	-	-	A/ μ s
Case temperature	50	75	50	75	°C
Equivalent values for RC circuit	10Ω / 0.47μF	10Ω / 0.47μF	10Ω / 0.47μF	10Ω / 0.47μF	

On-state Conduction

Parameter	ST333S	Units	Conditions			
$I_{T(AV)}$ Max. average on-state current @ Case temperature	330	A	180° conduction, half sine wave			
	75	°C				
$I_{T(RMS)}$ Max. RMS on-state current	518		DC @ 63°C case temperature			
I_{TSM} Max. peak, one half cycle, non-repetitive surge current	11000	A	t = 10ms	No voltage reapplied	Sinusoidal half wave, Initial $T_J = T_{J\max}$	
	11520					
	9250					
	9700					
I^2t Maximum I^2t for fusing	605	KA ² s	t = 10ms	No voltage reapplied	Sinusoidal half wave, Initial $T_J = T_{J\max}$	
	550					
	430		t = 8.3ms	100% V_{RRM} reapplied		
	390		t = 8.3ms	reapplied		
$I^2\sqrt{t}$ Maximum $I^2\sqrt{t}$ for fusing	6050	KA ² /s	t = 0.1 to 10ms, no voltage reapplied			

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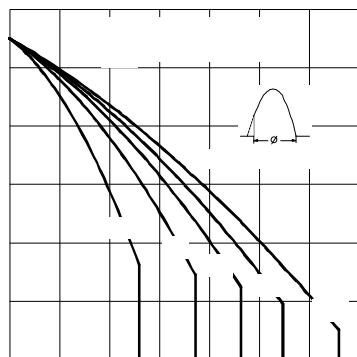


Fig. 1 - Current Ratings Characteristics

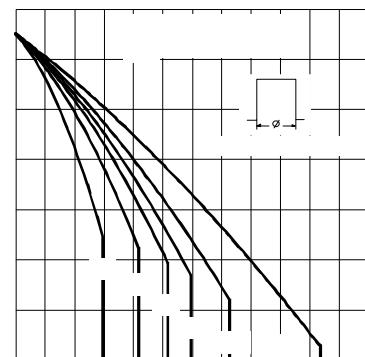


Fig. 2 - Current Ratings Characteristics

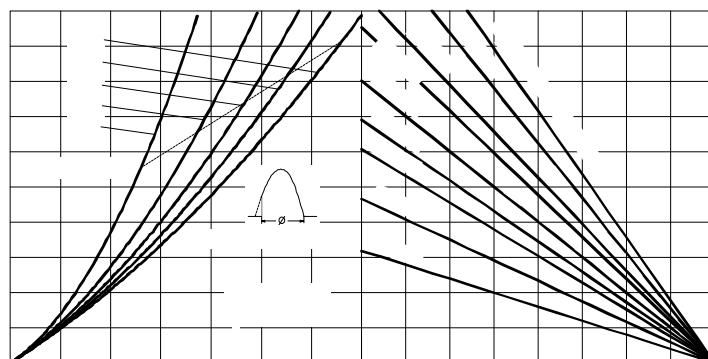


Fig. 3 - On-state Power Loss Characteristics

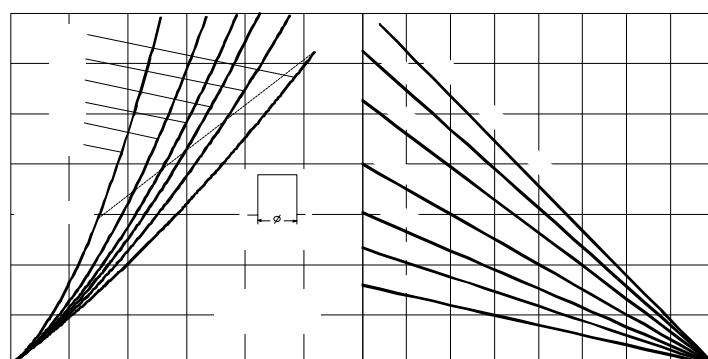


Fig. 4 - On-state Power Loss Characteristics

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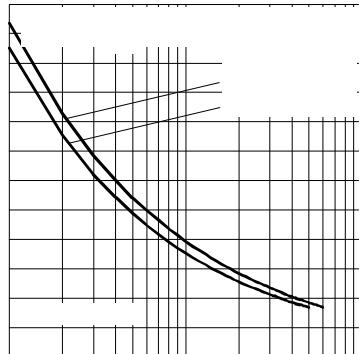


Fig. 5 - Maximum Non-repetitive Surge Current

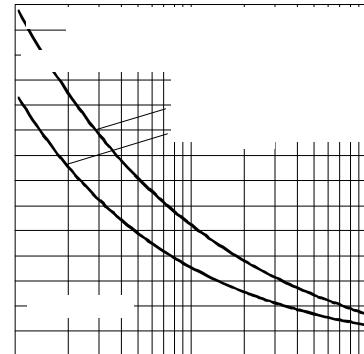


Fig. 6 - Maximum Non-repetitive Surge Current

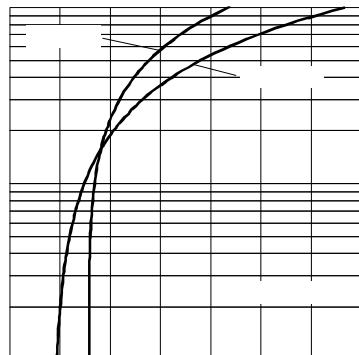


Fig. 7 - On-state Voltage Drop Characteristics

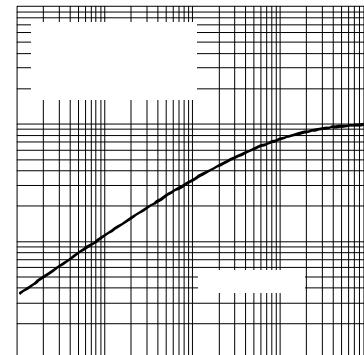


Fig. 8 - Thermal Impedance Z_{thJC} Characteristic

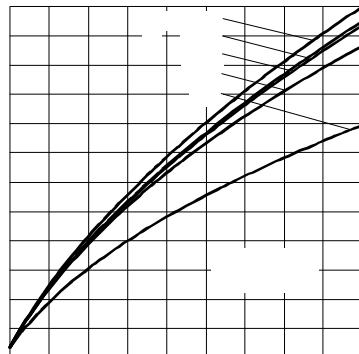


Fig. 9 - Reverse Recovered Charge Characteristics

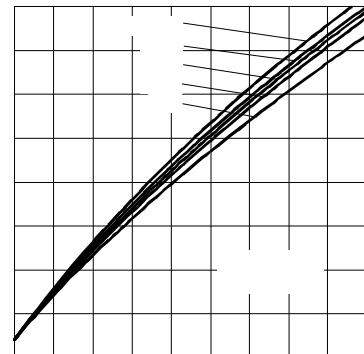


Fig. 10 - Reverse Recovery Current Characteristics

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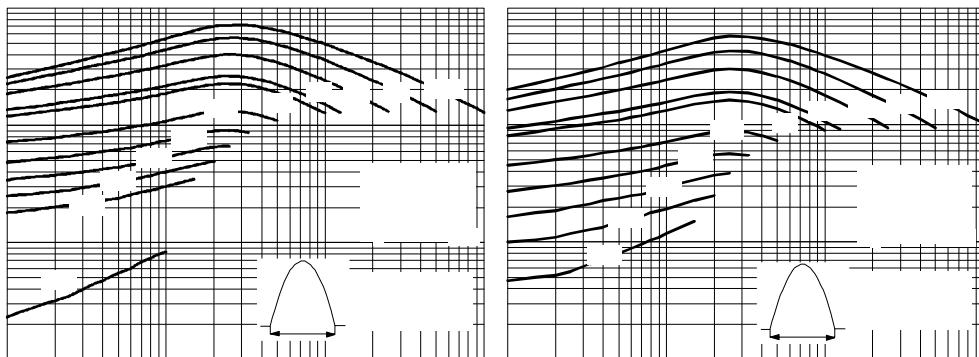


Fig. 11 - Frequency Characteristics

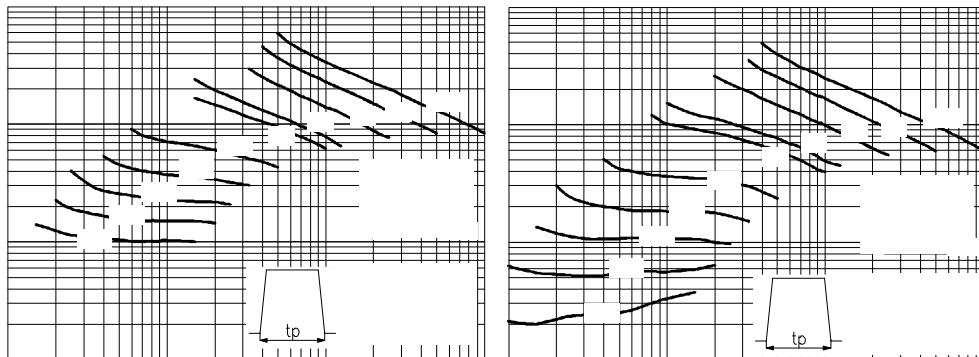


Fig. 12 - Frequency Characteristics

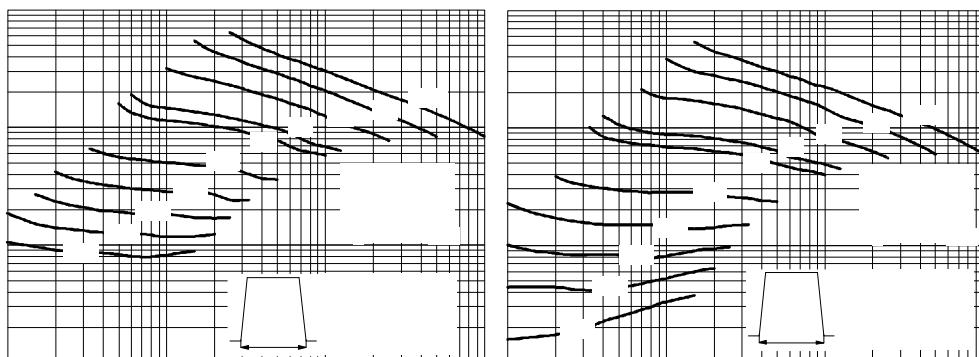


Fig. 13 - Frequency Characteristics

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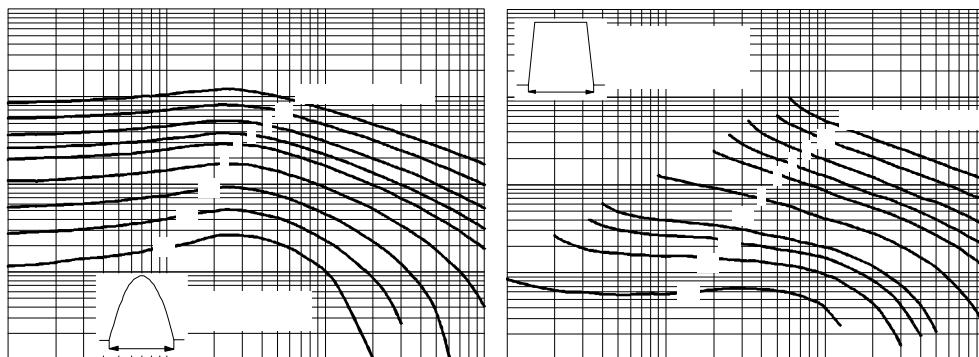


Fig. 14 - Maximum On-state Energy Power Loss Characteristics

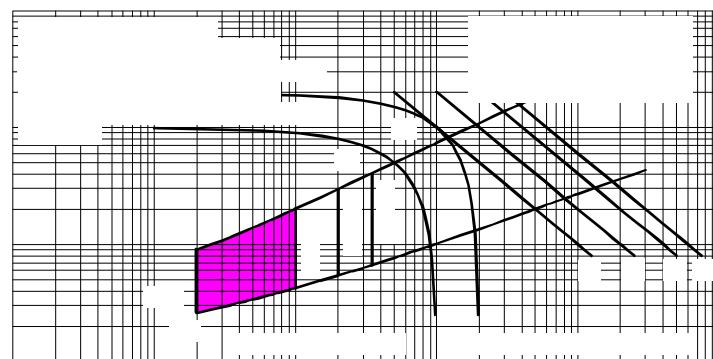


Fig. 15 - Gate Characteristics

ST333S Series**On-state Conduction**

Parameter	ST333S	Units	Conditions	
V_{TM}	Max. peak on-state voltage	1.51	V	$I_{TM} = 1040A, T_J = T_J \text{ max}, t_p = 10\text{ms sine wave pulse}$
$V_{T(TO)1}$	Low level value of threshold voltage	0.91		$(16.7\% \times \pi \times I_{T(AV)} < I < \pi \times I_{T(AV)}, T_J = T_J \text{ max.})$
$V_{T(TO)2}$	High level value of threshold voltage	0.92		$(I > \pi \times I_{T(AV)}), T_J = T_J \text{ max.}$
r_{t1}	Low level value of forward slope resistance	0.58	mΩ	$(16.7\% \times \pi \times I_{T(AV)} < I < \pi \times I_{T(AV)}, T_J = T_J \text{ max.})$
r_{t2}	High level value of forward slope resistance	0.58		$(I > \pi \times I_{T(AV)}), T_J = T_J \text{ max.}$
I_H	Maximum holding current	600	mA	$T_J = 25^\circ\text{C}, I_T > 30\text{A}$
I_L	Typical latching current	1000		$T_J = 25^\circ\text{C}, V_A = 12\text{V}, R_a = 6\Omega, I_G = 1\text{A}$

Switching

Parameter	ST333S	Units	Conditions	
di/dt	Max. non-repetitive rate of rise of turned-on current	1000	A/μs	$T_J = T_J \text{ max}, V_{DRM} = \text{rated } V_{DRM}$ $I_{TM} = 2 \times di/dt$
t_d	Typical delay time	1.0		$T_J = 25^\circ\text{C}, V_{DM} = \text{rated } V_{DRM}, I_{TM} = 50\text{A DC}, t_p = 1\mu\text{s}$ Resistive load, Gate pulse: 10V, 5Ω source
t_q	Max. turn-off time	Min 10 Max 30		$T_J = T_J \text{ max}, I_{TM} = 550\text{A}, \text{commutating } di/dt = 40\text{A}/\mu\text{s}$ $V_R = 50\text{V}, t_p = 500\mu\text{s}, dv/dt: \text{see table in device code}$

Blocking

Parameter	ST333S	Units	Conditions	
dv/dt	Maximum critical rate of rise of off-state voltage	500	V/μs	
$I_{RRM/DRM}$	Max. peak reverse and off-state leakage current	50	mA	$T_J = T_J \text{ max, rated } V_{DRM}/V_{RRM} \text{ applied}$

Triggering

Parameter	ST333S	Units	Conditions	
P_{GM}	Maximum peak gate power	60	W	$T_J = T_J \text{ max, } f = 50\text{Hz, d\%} = 50$
$P_{G(AV)}$	Maximum average gate power	10		
I_{GM}	Max. peak positive gate current	10	A	$T_J = T_J \text{ max, } t_p \leq 5\text{ms}$
$+V_{GM}$	Maximum peak positive gate voltage	20		
$-V_{GM}$	Maximum peak negative gate voltage	5	V	$T_J = T_J \text{ max, } t_p \leq 5\text{ms}$
I_{GT}	Max. DC gate current required to trigger	200		
V_{GT}	Max. DC gate voltage required to trigger	3	V	$T_J = 25^\circ\text{C}, V_A = 12\text{V, Ra = 6\Omega}$
I_{GD}	Max. DC gate current not to trigger	20	mA	
V_{GD}	Max. DC gate voltage not to trigger	0.25	V	$T_J = T_J \text{ max, rated } V_{DRM} \text{ applied}$

ST333S Series

Thermal and Mechanical Specifications

Parameter	ST333S	Units	Conditions
T _J Max. junction operating temperature range	-40 to 125	°C	
T _{stg} Max. storage temperature range	-40 to 150		
R _{thJC} Max. thermal resistance, junction to case	0.10	K/W	DC operation
R _{thCS} Max. thermal resistance, case to heatsink	0.03		Mounting surface, smooth, flat and greased
T Mounting torque, $\pm 10\%$	48.5 (425)	Nm (lbf-in)	Non lubricated threads
wt Approximate weight	535	g	
Case style	TO-209AE (TO-118)	See Outline Table	

ΔR_{thJC} Conduction

(The following table shows the increment of thermal resistance R_{thJC} when devices operate at different conduction angles than DC)

Conduction angle	Sinusoidal conduction	Rectangular conduction	Units	Conditions
180°	0.011	0.008	K/W	T _j = T _j max.
120°	0.013	0.014		
90°	0.017	0.018		
60°	0.025	0.026		
30°	0.041	0.042		

Ordering Information Table

Device Code	ST	33	3	S	08	P	F	M	0	
	1	2	3	4	5	6	7	8	9	10
1	- Thyristor									
2	- Essential part number									
3	- 3 = Fast turn off									
4	- S = Compression bonding Stud									
5	- Voltage code: Code x 100 = V _{RRM} (See Voltage Ratings table)									
6	- P = Stud base 3/4" 16UNF-2A									
	M = Stud base metric threads M24 x 1.5									
7	- Reapplied dv/dt code (for t _q test condition)									
8	- t _q code									
9	- 0 = Eyelet terminals (Gate and Aux. Cathode Leads)									
	1 = Fast-on terminals (Gate and Aux. Cathode Leads)									
	3 = Threaded top terminal 3/8" 24UNF-2A									
10	- Critical dv/dt:									
	None = 500V/ μ sec (Standard value)									
	L = 1000V/ μ sec (Special selection)									
dv/dt - t_q combinations available										
t_q(μs)		dv/dt (V/ μ s)	20	50	100	200	400			
10		CN	DN	EN	--	--				
12		CM	DM	EM	FM *	--				
15		CL	DL	EL	FL *	HL				
18		CP	DP	EP	FP	HP				
20		CK	DK	EK	FK	HK				
25		--	--	--	FJ	HJ				
30		--	--	--	--	HH				

*Standard part number.
All other types available only on request.

ST333S Series

Outline Table

